



SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

LC74763 LC74763M — CMOS IC On-Screen Display LSI

Overview

The LC74763 and LC74763M are on-screen display CMOS LSIs that superimpose text and low-level graphics onto a TV screen (video signal) under the control of a microcontroller. The display characters have a 12 by 18 dots structure, and 128 characters are provided.

Features

- Display structure: 12 lines by 24 characters (up to 288 characters)
- Maximum character display: Up to 288 characters
- Character configuration: 12 (W) by 18 (H) dots structure
- Number of characters: 128 characters (128 plus space 2 fonts)
- Character sizes: Three sizes (normal, double, and triple sizes)
- Display starting positions: 64 horizontal and 64 vertical locations
- Reverse video function: Characters can be inverted on a per character basis.
- Flashing types: Two types with periods of 0.5 and 1.0 second on a per character basis (duty fixed at 50%)
- Background color: One of eight colors (when internal synchronization used)
- External control input: Serial data input in 8-bit units
- Built-in horizontal/vertical sync separation circuit, AFC circuit, and synchronization detector
- Video output: Composite video signal output in NTSC, PAL, PAL-M, PAL-N, PAL60, NTSC4.43, or SECAM format

- Any and all SANYO Semiconductor Co.,Ltd. products described or contained herein are, with regard to "standard application", intended for the use as general electronics equipment. The products mentioned herein shall not be intended for use for any "special application" (medical equipment whose purpose is to sustain life, aerospace instrument, nuclear control device, burning appliances, transportation machine, traffic signal system, safety equipment etc.) that shall require extremely high level of reliability and can directly threaten human lives in case of failure or malfunction of the product or may cause harm to human bodies, nor shall they grant any guarantee thereof. If you should intend to use our products for new introduction or other application different from current conditions on the usage of automotive device, communication device, office equipment, industrial equipment etc. , please consult with us about usage condition (temperature, operation time etc.) prior to the intended use. If there is no consultation or inquiry before the intended use, our customer shall be solely responsible for the use.
- Specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.

SANYO Semiconductor Co., Ltd.

<http://semicon.sanyo.com/en/network>

LC74763, LC74763M

Specifications

Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V _{DD} max	V _{DD1} , V _{DD2} pins	V _{SS} – 0.3 to V _{SS} + 7.0	V
Maximum input voltage	V _{IN} max	All input pins	V _{SS} – 0.3 to V _{DD} + 0.3	V
Maximum output voltage	V _{OUT} max	H _{SYNC} _{OUT} , V _{SYNC} _{OUT} , S _{YNC} _{DET} pins	V _{SS} – 0.3 to V _{DD} + 0.3	V
Allowable power dissipation	P _d max		300	mW
Operating temperature	T _{opr}		-30 to +70	°C
Storage temperature	T _{stg}		-40 to +125	°C

Allowable Operating Ranges at Ta = -30 to +70°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Supply voltage	V _{DD1}	V _{DD1} pin	4.5	5.0	5.5	V
	V _{DD2}	V _{DD2} pin	4.5	5.0	1.27 V _{DD1}	V
Input high level voltage	V _{IH1}	R _{ST} , CS, SIN, SCLK pins	0.8 V _{DD1}		V _{DD1} + 0.3	V
	V _{IH2}	SECAM, 525/625, NTSC/PAL, 3.58/4.43 pins	0.7 V _{DD1}		V _{DD1} + 0.3	V
Input low level voltage	V _{IL1}	R _{ST} , CS, SIN, SCLK	V _{SS} – 0.3		0.2 V _{DD1}	V
	V _{IL2}	SECAM, 525/625, NTSC/PAL, 3.58/4.43 pins	V _{SS} – 0.3		0.3 V _{DD1}	V
Input voltage	V _{IN}	FC, AMP _{IN} pins	V _{SS} – 0.3		V _{DD1} + 0.3	V
Composite video signal input voltage	V _{IN1}	CV _{IN} pins		2 V _{PP}		V
	V _{IN2}	CV _{CR} pins		2 V _{PP}		V
	V _{IN3}	S _{YNC} _{IN} pins		2 V _{PP}	2.5 V _{PP}	V
Oscillator frequency	F _{OSC1}	Xtal _{IN1} , Xtal _{OUT1} , Xtal _{IN2} , Xtal _{OUT2} pins; 4fsc	NTSC		14.318	MHz
			PAL		17.734	MHz
			PAL-M		14.302	MHz
			PAL-N		14.328	MHz

Electrical Characteristics at Ta = -30 to +70°C, with V_{DD1} = V_{DD2} = 5 V unless otherwise specified

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Output off leakage current	I _{leak1}	CV _{OUT} pin			10	µA
Input off leakage current	I _{leak2}	CV _{IN} , CV _{CR} pins			10	µA
Output high level voltage	V _{OH}	H _{SYNC} _{OUT} , V _{SYNC} _{OUT} , S _{YNC} _{DET} , SECAM, 525/625, NTSC/PAL, 3.58/4.43, AMP _{OUT} , PD _{OUT} pins; V _{DD1} = 4.5 V, I _{OH} = -1.0 mA	3.5			V
Output low level voltage	V _{OL}	H _{SYNC} _{OUT} , V _{SYNC} _{OUT} , S _{YNC} _{DET} , SECAM, 525/625, NTSC/PAL, 3.58/4.43, AMP _{OUT} , PD _{OUT} pins; V _{DD1} = 4.5 V, I _{OL} = 1.0 mA			1.0	V
Input current	I _{IH}	R _{ST} , CS, SIN, SCLK, SECAM, 525/625, NTSC/PAL, 3.58/4.43 pins; V _{IN} = V _{DD1}			1	µA
	I _{IL}	SECAM, 525/625, NTSC/PAL, 3.58/4.43 pin; V _{IN} = V _{SS1}	-1			µA
Oscillator frequency	F _{OSC3}	VCO _{IN} , VCO _{OUT} pins; FC = 1/2 V _{DD1}		14.12		MHz
Operating current dissipation	I _{DD1}	V _{DD1} pin; All outputs open, Xtal: 4fsc			15	mA
	I _{DD2}	V _{DD2} pin; V _{DD2} = 5.0 V			20	mA

Timing Characteristics at Ta = -30 to +70°C, V_{DD} = 5 ±0.5 V

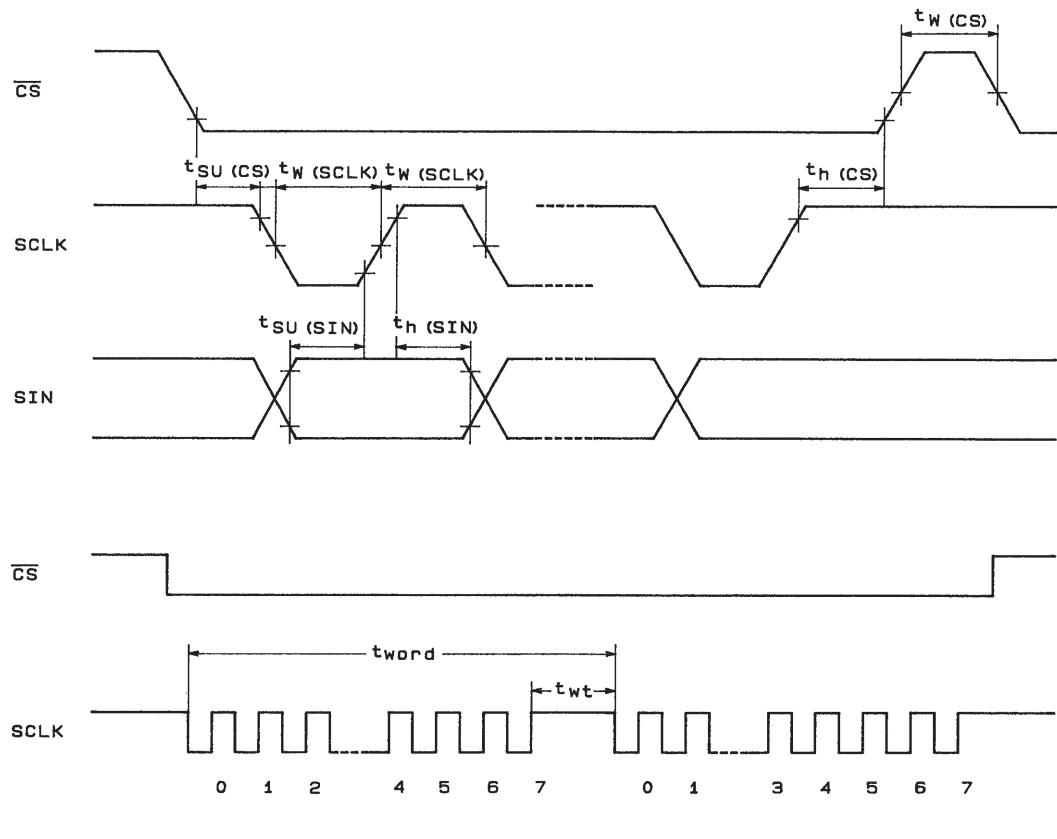
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Minimum input pulse width	t _{W(SCLK)}	SCLK pin	200			ns
	t _{W(CS)}	CS pin (during periods when CS is high)	1			µs
Data setup time	t _{SU(CS)}	CS pin	200			ns
	t _{SU(SIN)}	SIN pin	200			ns
Data hold time	t _{h(CS)}	CS pin	2			µs
	t _{h(SIN)}	SIN pin	200			ns
One word write time	t _{word}	Write time for 8 bits of data	4.2			µs
	t _{wt}	RAM data write time	1			µs

LC74763, LC74763M

Pin Functions

Pin No.	Symbol	Function	Description
1	V_{SS}	Ground	Ground connection
2	Xtal _{IN1}	Crystal oscillator connection	Connection for the crystal and capacitor used to form the crystal oscillator that generates the internal synchronization signal. The oscillator can be selected with a command switch.
3	Xtal _{OUT1}		
4	H SYNC _{OUT}	Horizontal synchronization output	Outputs the horizontal synchronization signal (AFC). The output polarity can be selected (metal option). Also functions as general output port (command switch).
5	Xtal _{IN2}	Crystal oscillator connection	Connection for the crystal and capacitor used to form the crystal oscillator that generates the internal synchronization signal.
6	Xtal _{OUT2}		
7	V SYNC _{OUT}	Vertical synchronization output	Outputs the vertical synchronization signal. The output polarity can be selected (metal option). Also functions as general output port (command switch).
8	\overline{CS}	Enable input	Enables/disables serial data input. Serial data is enabled when this pin is low (hysteresis input). Pull-up resistor built in (metal option).
9	SIN	Data input	Serial data input (hysteresis input). Pull-up resistor built in (metal option).
10	SCLK	Clock input	Clock input for serial data input (hysteresis input). Pull-up resistor built in (metal option).
11	SECAM	SECAM mode switch input/output (command switch)	During input, switches between SECAM and other modes. During output, functions as general output port or internal V output (command switch). Low = other modes, high = SECAM mode
12	525/625	525/625 switch input/output (command switch)	During input, switches between 525 scan lines and 625 scan lines. During output, functions as general output port or character data output (command switch). Low = 525 lines, high = 625 lines
13	$\overline{NTSC/PAL}$	NTSC/PAL switch input/output (command switch)	Switches the color mode between NTSC and PAL. During output, functions as general output port or frame data output (command switch). Low = NTSC, high = PAL
14	3.58/4.43	3.58/4.43 switch input/output (command switch)	Switch FSC between 3.58 MHz and 4.43 MHz. During output, functions as general output port or halftone output (command switch). Low = 3.58, high = 4.43
15	\overline{RST}	Reset input	System reset input pin, low is active (hysteresis input). Pull-up resistor built in (metal option).
16	CV _{OUT}	Video signal output	Composite video output
17	V_{DD2}	Power supply connection	Power supply connection for composite video signal level generation
18	CV _{IN}	Video signal input	Composite video input
19	CV _{CR}	Video signal input	SECAM chroma signal input
20	SYNC _{IN}	Sync separator circuit input	Built-in sync separator circuit video signal input
21	SEP _C	Sync separator circuit	Built-in sync separator circuit
22	V_{SS}	Ground	Ground connection
23	PD _{OUT}	Control voltage output	AFC control voltage output
24	AMP _{IN}	AFC filter connection	Filter connection
25	AMP _{OUT}		
26	FC	Control voltage input	AFC control voltage input
27	VCO _{IN}	LC oscillator connection	VCO LC oscillator circuit coil and capacitor connection
28	VCO _{OUT}		
29	SYNC _{DET}	External synchronization signal detection output	Outputs the exclusive NOR of the horizontal synchronization signal (AFC) and CSYNC (sync separator). The output polarity can be selected (metal option). Also functions as general output port (command switch).
30	V_{DD1}	Power supply connection	Power supply connection (+5 V: digital system power supply)

Serial Data Input Timing

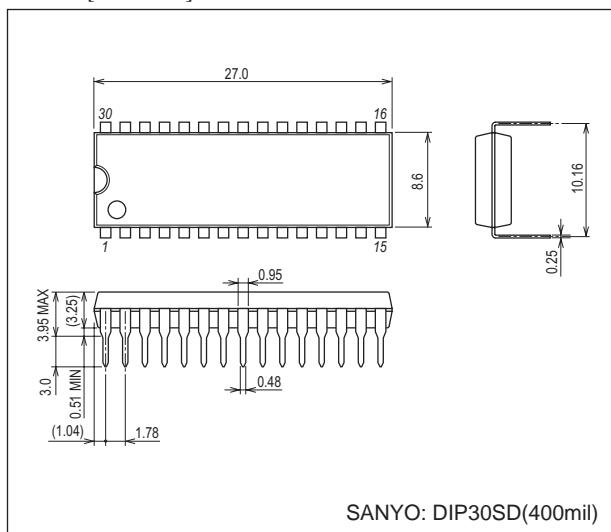


A03519

Package Dimensions

unit : mm (typ)

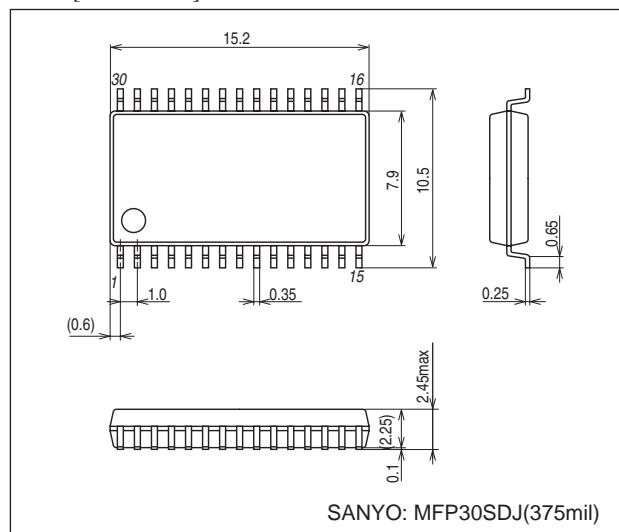
3196A [LC74763]



Package Dimensions

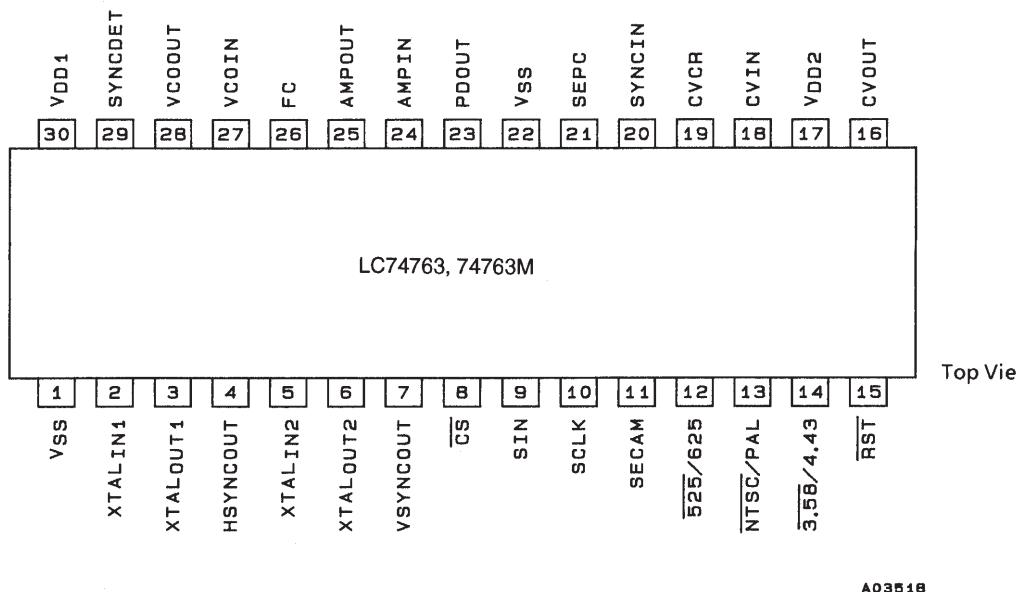
unit : mm (typ)

3312 [LC74763M]

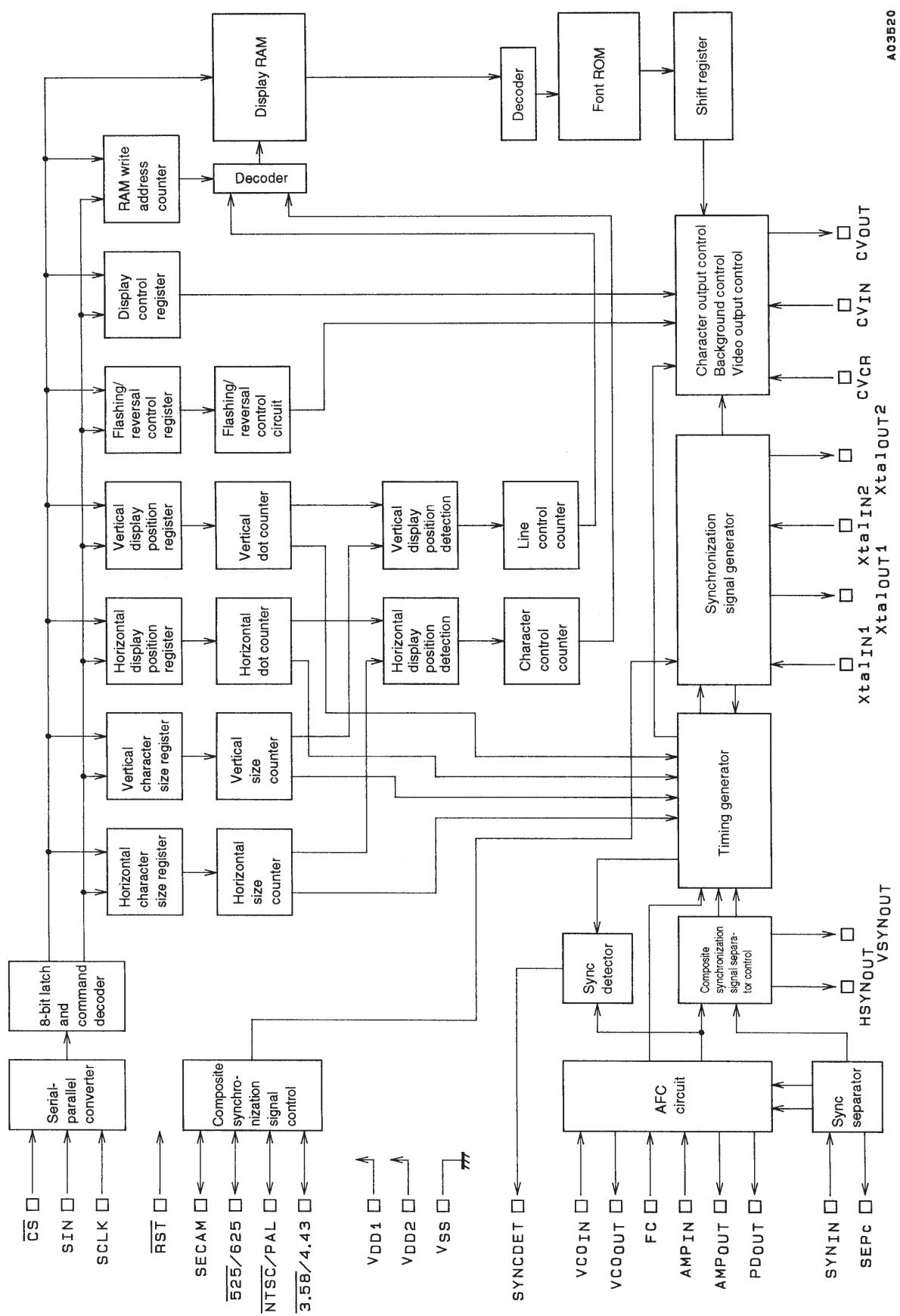


LC74763, LC74763M

Pin Assignment



System Block Diagram



Display Control Commands

Display control commands are input in an 8-bit serial format. Commands consist of a command identification code in the first byte and data in the second and following bytes. The following commands are supported.

- ① COMMAND0: Display memory (VRAM) write address setting command
- ② COMMAND1: Display character data write command
- ③ COMMAND2: Vertical display start position and character size (lines 1 and 2) setting command
- ④ COMMAND3: Horizontal display start position and character size (lines 9 and 11) setting command
- ⑤ COMMAND4: Display control setting command 1
- ⑥ COMMAND5: Display control setting command 2
- ⑦ COMMAND6: Display control setting command 3
- ⑧ COMMAND7: Display control setting command 4

Display Control Command Table

Command	First byte								Second byte							
	Command identification code				Data				Data							
	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0
COMMAND0 Write address	1	0	0	0	V3	V2	V1	V0	0	0	0	H4	H3	H2	H1	H0
COMMAND1 Character write	1	0	0	1	0	0	at2	at1	c7	c6	c5	c4	c3	c2	c1	c0
COMMAND2 Vertical display start position	1	0	1	0	SZ 21	SZ 20	SZ 11	SZ 10	0	0	VP 5	VP 4	VP 3	VP 2	VP 1	VP 0
COMMAND3 Horizontal display start position	1	0	1	1	SZ B1	SZ B0	SZ 91	SZ 90	0	0	HP 5	HP 4	HP 3	HP 2	HP 1	HP 0
COMMAND4 Display control 1	1	1	0	0	RST	RAM	OSC	RND	0	I/N	BLK 1	BLK 0	BK 1	ATS	0	DSP
COMMAND5 Display control 2	1	1	0	1	PH 2	PH 1	PH 0	I/E	0	TST	CHAL	BKL	RSL 1	RSL 0	CVM	XTS
COMMAND6 Display control 3	1	1	1	0	MOD 3	MOD 2	MOD 1	MOD 0	0	HFI	M30S	SMS	IOS	BCL 1	BCL 0	CB
COMMAND70 Display control 4	1	1	1	1	0	0	0	LINS	0	VCOS 1	LIN 5	LIN 4	LIN 3	LIN 2	LIN 1	LIN 0
COMMAND71 Display control 5	1	1	1	1	0	1	0	LINS	0	EG 2	PS 2	PS 1	VMN	SVIS	VNS	VSS
COMMAND72 Display control 6	1	1	1	1	1	0	0	LINS	0	0	0	0	MOD 3	MOD 2	MOD 1	MOD 0
COMMAND73 Display control 7	1	1	1	1	1	1	0	LINS	0	0	0	0	VCOS 2	SOUT	VOUT	HOUT

Once the command identification code in the first byte is written, it is stored internally until the first byte of the following command is written. However, when the display character data write command (COMMAND1) is written, the system becomes locked in display character data write mode, and the first byte cannot be overwritten.

When the \overline{CS} pin is set high the command state is set to COMMAND0, i.e., display memory write address setting mode.

LC74763, LC74763M

① COMMAND0: Display Memory Write Address Setting Command

First data byte

DA0 to DA7	Register name	Register content		Note
		State	Function	
7	—	1	The command 0 identification code: sets the display memory write address.	
6	—	0		
5	—	0		
4	—	0		
3	V3	0		
		1		
2	V2	0		
		1		
1	V1	0		
		1		
0	V0	0		
		1		

Second byte

DA0 to DA7	Register name	Register content		Note
		State	Function	
7	—	0	Second byte identification code	
6	—	0		
5	—	0		
4	H4	0		
		1		
3	H3	0		
		1		
2	H2	0		
		1		
1	H1	0		
		1		
0	H0	0		
		1		

Note: When the chip is reset by the RST pin, the register states (bits) are all cleared to 0.

② COMMAND1: Display Character Data Write Setting Command

First byte

DA0 to DA7	Register name	Register content		Note
		State	Function	
7	—	1	The command 1 identification code: sets the display memory write address.	When this command is entered, the chip locks in display character write mode until the CS pin is set high.
6	—	0		
5	—	0		
4	—	1		
3	—	0		
2	—	0		
1	at2	0	Turns character attribute 2 off.	Specifies highlight or flashing.
		1	Turns character attribute 2 on.	
0	at1	0	Turns character attribute 1 off.	Specifies reverse video.
		1	Turns character attribute 1 on.	

LC74763, LC74763M

Second byte

DA0 to DA7	Register name	Register content		Note
		State	Function	
7	c7	0	Character code (from 00 to 7F, FE, FF)	
		1		
6	c6	0		
		1		
5	c5	0		
		1		
4	c4	0		
		1		
3	c3	0		
		1		
2	c2	0		
		1		
1	c1	0		
		1		
0	c0	0		
		1		

Note: When the chip is reset by the RST pin, the register states (bits) are all cleared to 0.

③ COMMAND2: Vertical Display Position Setting Command

First byte

DA0 to DA7	Register name	Register content			Note
		State	Function		
7	—	1	The command 2 identification code: sets the vertical display position.		
6	—	0			
5	—	1			
4	—	0			
3	SZ21	0	SZ20	0	Character size for the second line
		1	SZ21	1	
2	SZ20	0	0	Normal size	
		1	1	Triple size	
1	SZ11	0	SZ10	0	Character size for the first line
		1	SZ11	1	
0	SZ10	0	0	Normal size	
		1	1	Triple size	

Second byte

DA0 to DA7	Register name	Register content			Note	
		State	Function			
7	—	0	Second byte identification code		The six bits VP0 to VP5 specify the vertical display start position. The weight of the lsb is $1 \times H$.	
6	—	0				
5	VP5 (MSB)	0	The vertical display start position is given by			
		1	$VS = H \times \left(\sum_{n=0}^5 2^n VP_n \right)$			
4	VP4	0	where H is the horizontal synchronization pulse period.			
		1				
3	VP3	0				
		1				
2	VP2	0				
		1				
1	VP1	0				
		1				
0	VP0 (LSB)	0				
		1				

Note: When the chip is reset by the RST pin, the register states (bits) are all cleared to 0.

LC74763, LC74763M

④ COMMAND3: Horizontal Display Position Setting Command

First byte

DA0 to DA7	Register name	Register content			Note	
		State	Function			
7	—	1	The command 3 identification code: sets the horizontal display position.			
6	—	0				
5	—	1				
4	—	1				
3	SZB1	0				
		1				
2	SZB0	0	Normal size	Double size		
		1	Triple size	Normal size		
1	SZ91	0				
		1				
0	SZ90	0	Normal size	Double size		
		1	Triple size	Normal size		

Second byte

DA0 to DA7	Register name	Register content			Note	
		State	Function			
7	—	0	Second byte identification code			
6	—	0				
5	HP5 (MSB)	0				
		1				
4	HP4	0				
		1				
3	HP3	0				
		1				
2	HP2	0				
		1				
1	HP1	0	The horizontal display start position is given by $HS = Tc \times \left(\sum_{n=0}^5 2^n HP_n \right)$ where Tc is the period of the OSCIN and OSCOUT oscillator in operating mode.			
0	HP0 (LSB)	0				
		1				

Note: When the chip is reset by the \bar{RST} pin, the register states (bits) are all cleared to 0.

⑤ COMMAND4: Display Control Setting Command 1

First byte

DA0 to DA7	Register name	Register content			Note	
		State	Function			
7	—	1	The command 4 identification code: sets display control parameters.			
6	—	1				
5	—	0				
4	—	0				
3	RST _{SYS}	0	This reset occurs when the \bar{CS} pin goes low, and the reset state cleared when the \bar{CS} pin goes high.			
		1		Resets all registers. (Clears all registers to 0.)		
2	RAM _{ERS}	0	The RAM erase function requires at least 500 μ s. It is executed on DSPOFF.			
		1		Erases display RAM. (Sets display RAM to FF (hexadecimal).)		
1	OSC _{STP}	0	Continues crystal oscillator operation.	Only valid with character display off if external synchronization is used.		
		1	Stops the crystal oscillator.			
0	RND _{SEL}	0	Turns off rounding.	Only valid for double and triple size characters.		
		1	Turns on rounding.			

LC74763, LC74763M

Second byte

DA0 to DA7	Register name	Register content			Note
		State	Function		
7	—	0	Second byte identification code		
6	INT/NON	0	Interlaced		Switches between interlaced and non-interlaced display.
		1	Non-interlaced		
5	BLK1	0	BLK0	0	Changes the blanking size.
		1	BLK1	1	
4	BLK0	0	0	Blanking off	Character size blanking
		1	1	Frame size blanking	
3	BK1	0	Flashing period about 0.5 s		Sets the flashing period.
		1	Flashing period about 1 s		
2	ATS	0	Highlight function		Selects at2.
		1	Flashing function		
1	—	0			
0	DSPON	0	Character display off		Turns character output on and off.
		1	Character display on		

Note: When the chip is reset by the \overline{RST} pin, the register states (bits) are all cleared to 0.

⑥ COMMAND5: Display Control Setting Command 2

First byte

DA0 to DA7	Register name	Register content			Note	
		State	Function			
7	—	1	The command 5 identification code: sets display control parameters.			
6	—	1				
5	—	0				
4	—	1				
3	PH2	0	PHASE 2	PHASE 1	PHASE 0	Background color (phase)
		1	0	0	0	
2	PH1	0	0	0	1	NTSC PAL
		1	0	1	1	
1	PH0	0	0	1	0	
		1	1	1	1	
0	INT/EXT	0	External synchronization mode			Sets the phase of the background color for color burst.s2
		1	Internal synchronization mode			

LC74763, LC74763M

Second byte

DA0 to DA7	Register name	Register content				Note	
		State	Function				
7	—	0	Second byte identification code				
6	TST	0	Normal operation			Test mode should not be used. This bit should always be zero.	
		1	Test mode				
5	CHAL	0	Sets the character intensity level to about 85 IRE (bright white).			Switches the character intensity level.	
		1	Sets the character intensity level to about 72 IRE (white with a touch of grey).				
4	BKL	0	Sets the blanking intensity level to about 3 IRE (a deep black as a frame level).			Switches the blanking intensity level.	
		1	Sets the blanking intensity level to about 13 IRE (a dark grey as a frame level).				
3	RSL1	0	RSL1	RSL0	Intensity level	Amplitude	
		1	0	0	About 15 IRE	About 60 IRE	
2	RSL0	0	0	1	About 30 IRE	About 60 IRE	Switches the background intensity level.
		1	1	0	About 45 IRE	About 60 IRE	
1	CV _{outmt}	0	Normal CV _{out} output				
		1	CV _{out} pedestal level output				
0	XTAL _{sel}	0	Selects XTAL1				Switches the oscillator circuit
		1	Selects XTAL2				

Note: When the chip is reset by the RST pin, the register states (bits) are all cleared to 0.

⑦ COMMAND6: Display Control Setting Command 3

First byte

DA0 to DA7	Register name	Register content				Note	
		State	Function				
7	—	1	The command 6 identification code: sets display control parameters.				
6	—	1					
5	—	1					
4	—	0					
3	MOD3	0	Sets Fsc to 3.58 MHz.			The logical or of this bit and the Fsc switching input pin (pin 14) is used.	
		1	Sets Fsc to 4.43 MHz.				
2	MOD2	0	Sets the color mode to NTSC.			The logical or of this bit and the color mode switching input pin (pin 13) is used.	
		1	Sets the color mode to PAL.				
1	MOD1	0	Sets the number of scan lines to 525 lines.			The logical or of this bit and the scan line count switching input pin (pin 12) is used.	
		1	Sets the number of scan lines to 625 lines.				
0	MOD0	0	Sets the mode to a mode other than SECAM.			The logical or of this bit and the mode switching input pin (pin 11) is used.	
		1	Sets the mode to SECAM mode.				

LC74763, LC74763M

Second byte

DA0 to DA7	Register name	Register content			Note	
		State	Function			
7	—	0	Second byte identification code			
6	HALF INT	0	Normal mode			
		1	Half internal synchronous mode			
5	P14OUT SEL	0	Halftone output		Selects P14 (3.58/4.43) output.	
		1	High output in internal synchronous mode			
4	SECAM SEL	0	In SECAM mode, only the character frame area is on.		Selects the CVCR "on" period.	
		1	In SECAM mode, the entire character display area is on.			
3	IOS	0	Sets the mode setting pin to be an input pin.		Switches the input/output direction of the mode setting pins.	
		1	Sets the mode setting pin to be an output pin.			
2	BCOL1	0	BCOL1	BCOL0	Background color	Determines whether a background color is displayed. (Only valid in internal synchronization mode.)
		1	0	0	Background color displayed	
1	BCOL0	0	0	1	No background color (about 13 IRE)	
		1	1	0	No background color (about 23 IRE)	
0	CBOFF	0	Outputs a color burst signal.			Only valid when either BCOL0 is 1 or BCOL1 is 1.
		1	Stops the output of color burst signals.			

Note: When the chip is reset by the RST pin, the register states (bits) are all cleared to 0.

⑧ COMMAND70: Display Control Setting Command 4

First byte

DA0 to DA7	Register name	Register content			Note
		State	Function		
7	—	1	The command 7 identification code: sets display control parameters.	Expansion command 0 identification code	Selects the upper or lower six bits when halftone output line mode is specified.
6	—	1			
5	—	1			
4	—	1			
3	—	0			
2	—	0	LINS	Selects the lower 6 bits (bits 0 to 5)	Selects the upper or lower six bits when halftone output line mode is specified.
1	—	0			
0	—	1			

Second byte

DA0 to DA7	Register name	Register content			Note	
		State	Function			
7	—	0	Second byte identification code		Selects VCO oscillation frequency.	
6	VCO SELECT1	0	VCO frequency is 14.12 MHz			
		1	VCO frequency is 7.07 MHz			
5	LIN5	0	Turns off (low) sixth line halftone output.		Used for the line 12 setting when LINS is high.	
		1	Turns on (high) sixth line halftone output.			
4	LIN4	0	Turns off (low) fifth line halftone output.		Used for the line 11 setting when LINS is high.	
		1	Turns on (high) fifth line halftone output.			
3	LIN3	0	Turns off (low) fourth line halftone output.		Used for the line 10 setting when LINS is high.	
		1	Turns on (high) fourth line halftone output.			
2	LIN2	0	Turns off (low) third line halftone output.		Used for the line 9 setting when LINS is high.	
		1	Turns on (high) third line halftone output.			
1	LIN1	0	Turns off (low) second line halftone output.		Used for the line 8 setting when LINS is high.	
		1	Turns on (high) second line halftone output.			
0	LIN0	0	Turns off (low) first line halftone output.		Used for the line 7 setting when LINS is high.	
		1	Turns on (high) first line halftone output.			

Note: When the chip is reset by the RST pin, the register states (bits) are all cleared to 0.

LC74763, LC74763M

⑨ COMMAND71: Display Control Setting Command 5

First byte

DA0 to DA7	Register name	Register content		Note
		State	Function	
7	—	1	The command 7 identification code: sets display control parameters	
6	—	1		
5	—	1		
4	—	1		
3	—	0		
2	—	1		
1	—	0		
0	LINS	0	Selects lower 6 bits (0 to 5).	Selects lower or upper 6 bits for half-tone output line setting.
		1	Selects upper 6 bits (6 to B).	

Second byte

DA0 to DA7	Register name	Register content		Note
		State	Function	
7	—	0	Second byte identification bit	
6	EGMODE 2SELECT	0	Normal display	
		1	Applies frame to inverted characters also.	
5	PORTSET SELECT2	0	Sets port output data	
		1	Sets port (output switching)	
4	PORTSET SELECT1	0	Sets port output data	
		1	Sets port (output switching)	
3	VMN SEL	0	Normal V signal	
		1	VMASK signal	
2	VINPsel	0	Normal I/O	
		1	V is input from P11.	
1	VNPsel	0	V rise detection	Selects V detection polarity.
		1	V fall detection	
0	VSEPsel	0	VSEP is about 9.3 µs.	Selects V separation time.
		1	VSEP is about 18.6 µs.	

Note: When the chip is reset by the RST pin, the register states (bits) are all cleared to 0.

⑩ COMMAND72: Display Control Setting Command 6

First byte

DA0 to DA7	Register name	Register content		Note
		State	Function	
7	—	1	The command 7 identification code: sets display control parameters	
6	—	1		
5	—	1		
4	—	1		
3	—	1		
2	—	0		
1	—	0		
0	LINS	0	Selects lower 6 bits (0 to 5).	Selects lower or upper 6 bits for half-tone output line setting.
		1	Selects upper 6 bits (6 to B).	

LC74763, LC74763M

Second byte

DA0 to DA7	Register name	Register content		Note
		State	Function	
7	—	0	Second byte identification bit	
6	—	0		
5	—	0		
4	—	0		
3	MOD3 SEL	0	Normal MOD3 (P14) output (PS1 = 1)	Specifies port output data when PS1 = 0.
		1	Specifies MOD3 general port output	
2	MOD2 SEL	0	Normal MOD2 (P13) output (PS1 = 1)	Specifies port output data when PS1 = 0.
		1	Specifies MOD2 general port output	
1	MOD1 SEL	0	Normal MOD1 (P12) output (PS1 = 1)	Specifies port output data when PS1 = 0.
		1	Specifies MOD1 general port output	
0	MOD0 SEL	0	Normal MOD0 (P11) output (PS1 = 1)	Specifies port output data when PS1 = 0.
		1	Specifies MOD0 general port output	

Note: When the chip is reset by the RST pin, the register states (bits) are all cleared to 0.

① COMMAND73: Display Control Setting Command 7

First byte

DA0 to DA7	Register name	Register content		Note
		State	Function	
7	—	1	The command 7 identification code: sets display control parameters	
6	—	1		
5	—	1		
4	—	1		
3	—	1	Expansion command 3 identification code	
2	—	1		
1	—	0		
0	LINS	0	Selects lower 6 bits (0 to 5).	Selects lower or upper 6 bits for half tone output line setting.
		1	Selects upper 6 bits (6 to B).	

Second byte

DA0 to DA7	Register name	Register content		Note
		State	Function	
7	—	0	Second byte identification bit	
6	—	0		
5	—	0		
4	—	0		
3	VCP SELECT2	0	No feedback resistance	Specifies VCO oscillator feedback resistance connection
		1	Feedback resistance	
2	SDETOUT SEL	0	Normal SOUT (P29) output (PS2 = 1)	Specifies port output data when PS2 = 0.
		1	Specifies SOUT general port output	
1	VOUT SEL	0	Normal VOUT (P7) output (PS2 = 1)	Specifies port output data when PS2 = 0.
		1	Specifies VOUT general port output	
0	HOUT SEL	0	Normal HOUT (P4) output (PS2 = 1)	Specifies port output data when PS2 = 0.
		1	Specifies HOUT general port output	

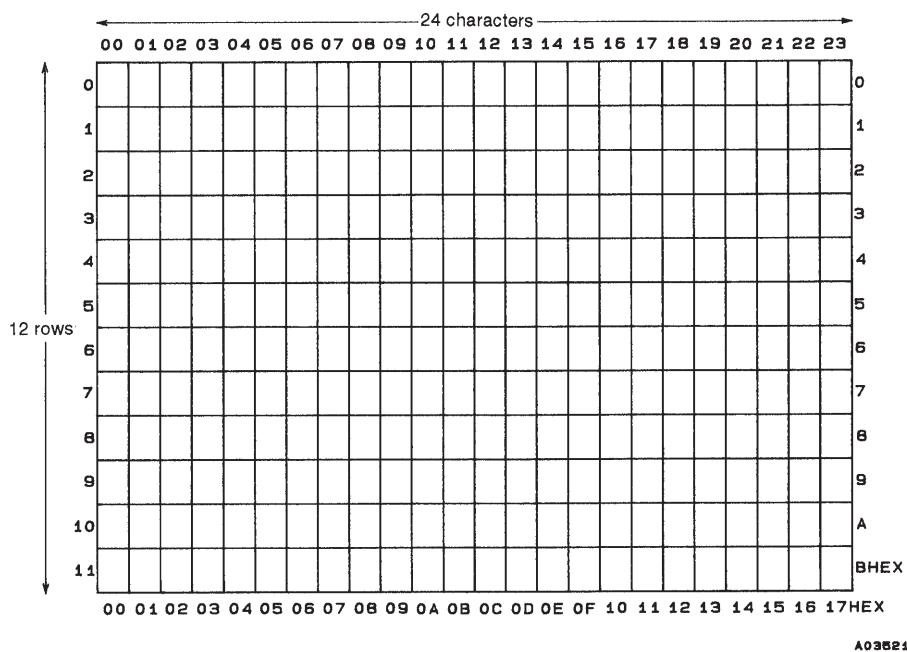
Note: When the chip is reset by the RST pin, the register states (bits) are all cleared to 0.

Display Configuration

The display consists of 12 rows of 24 characters each. Up to 288 characters can be displayed unless enlarged characters are displayed. Display memory addresses are expressed as a row address in the range 0 to B (hexadecimal) and a column address in the range 0 to 17 (hexadecimal).

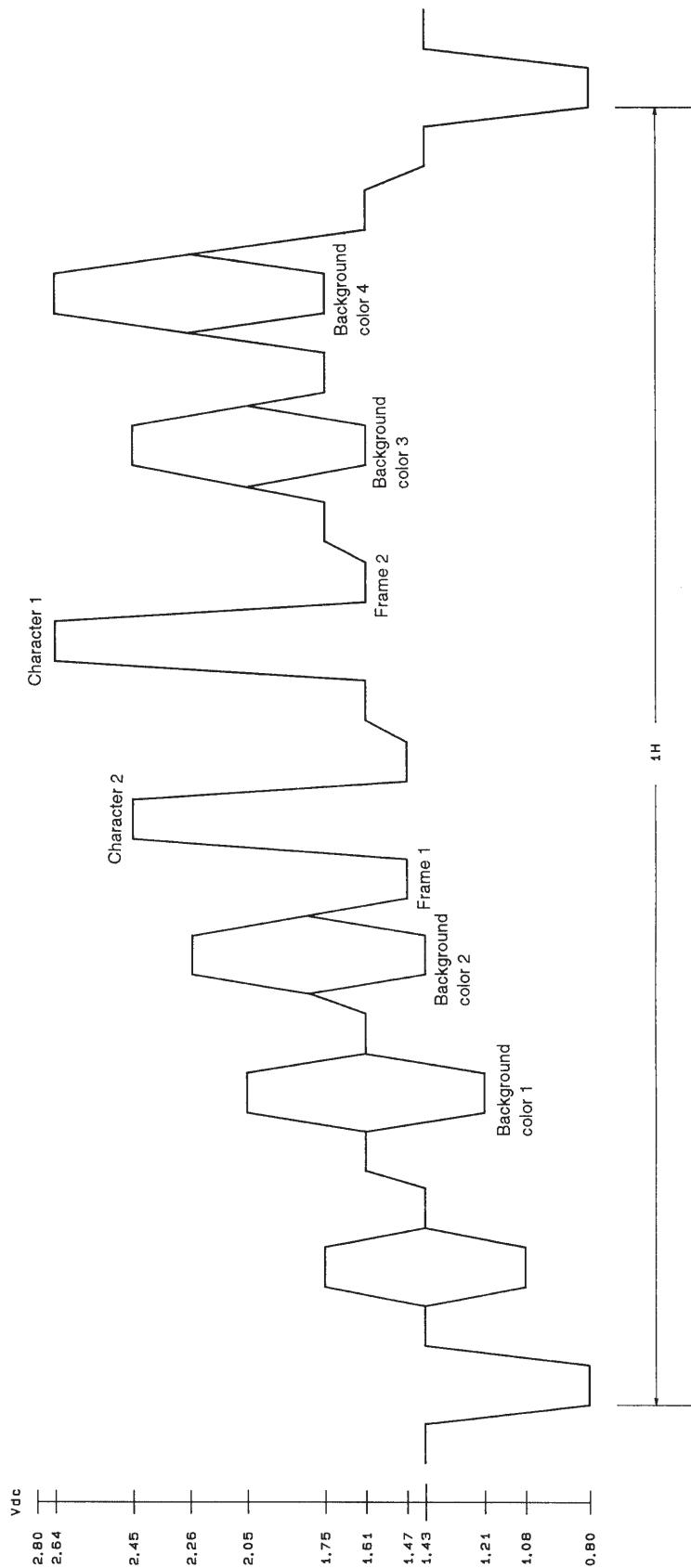
Display Configuration and Display Memory Addresses

24 characters by 12 rows



A03521

Composite Video Signal Output Levels (internally generated levels) Metal Option

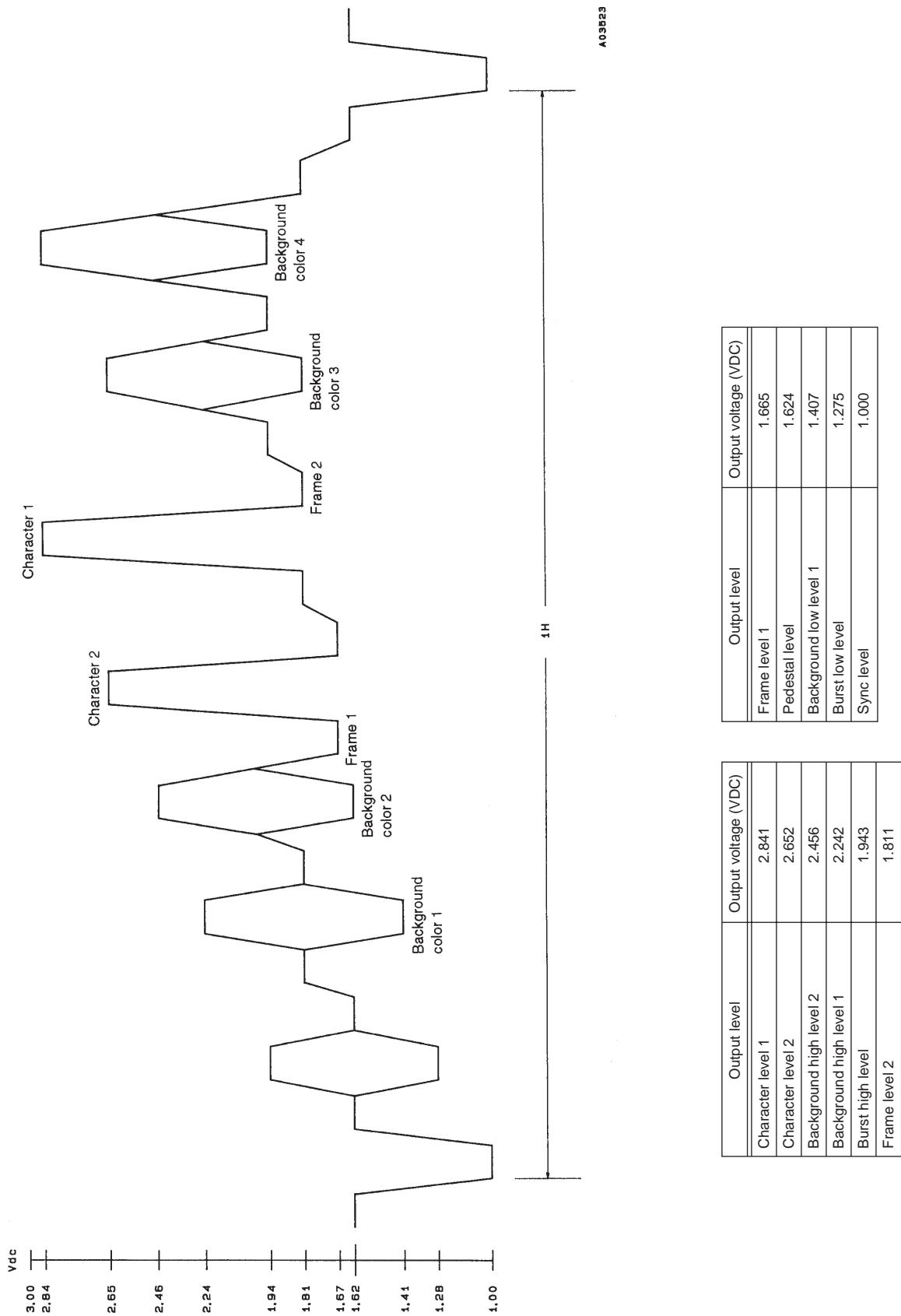


A03522

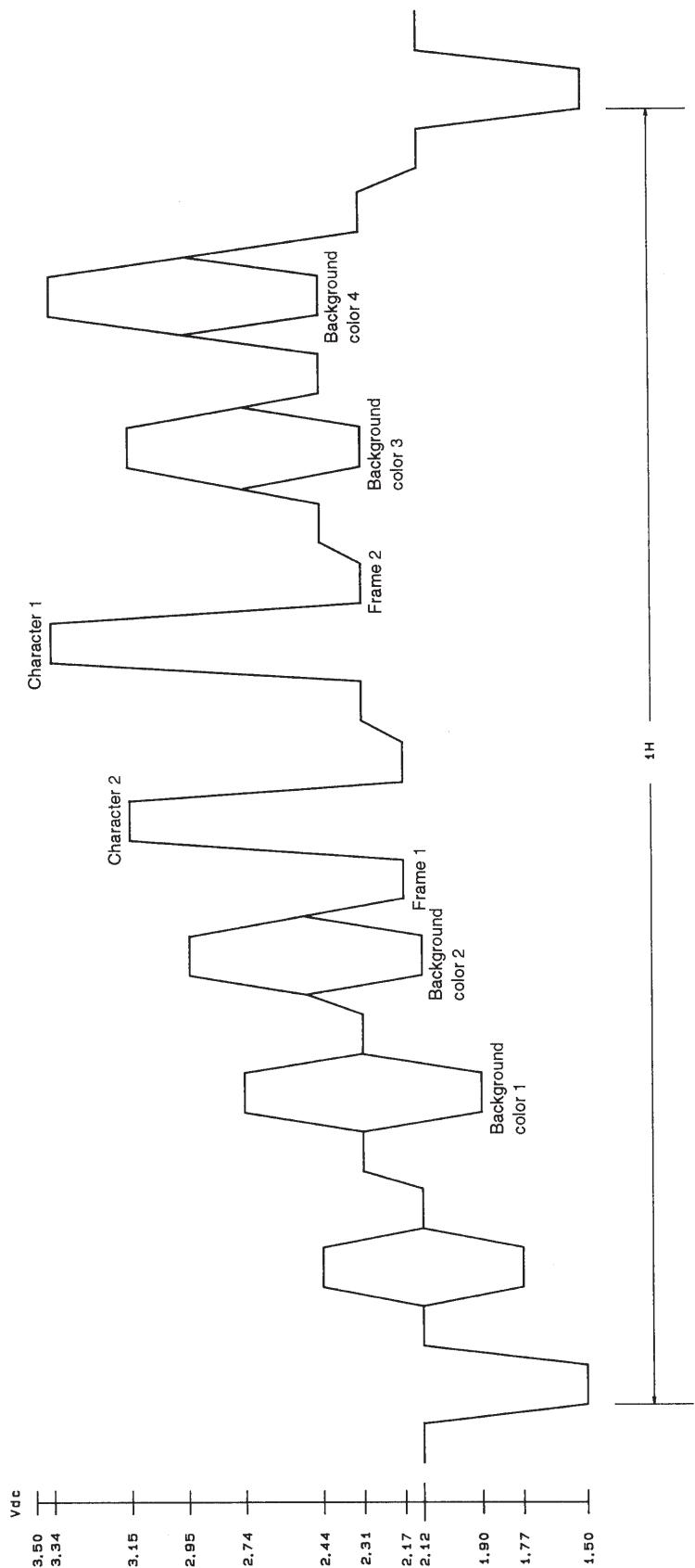
	Output level	Output voltage (VDC)
Frame level 1	2.638	1.465
Pedestal level	2.449	1.429
Background low level 1	2.262	1.212
Burst low level	2.047	1.080
Sync level	1.747	0.800
Frame level 2	1.610	

	Output level	Output voltage (VDC)
Character level 1	2.638	
Character level 2	2.449	
Background high level 2	2.262	
Background high level 1	2.047	
Burst high level	1.747	
Frame level 2	1.610	

Composite Video Signal Output Levels (internally generated levels) Metal Option



Composite Video Signal Output Levels (internally generated levels) Metal Option

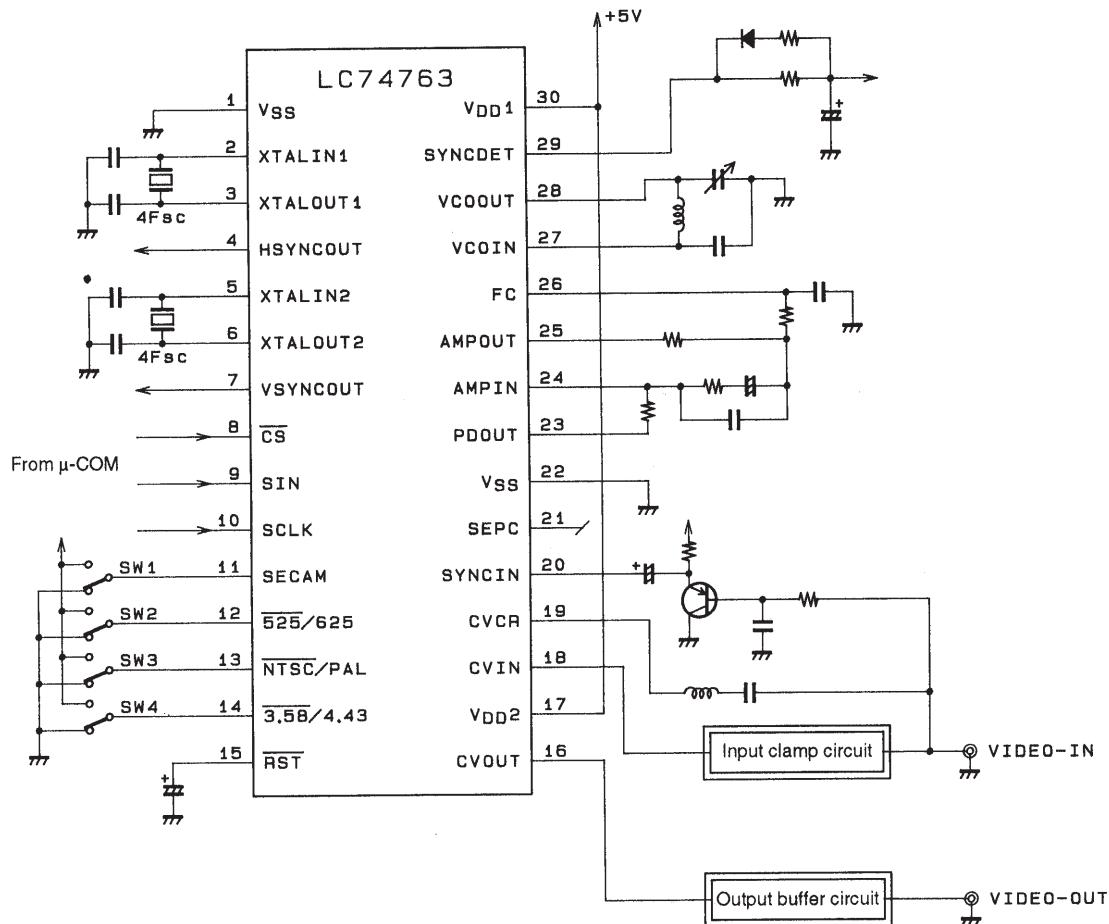


A03824

	Output level	Output voltage (VDC)	Output voltage (VDC)
Frame level 1		2.166	
Pedestal level		2.118	
Background low level 1		1.902	
Burst low level		1.770	
Sync level		1.500	

	Output level	Output voltage (VDC)
Character level 1		3.342
Character level 2		3.153
Background high level 2		2.950
Background high level 1		2.735
Burst high level		2.436
Frame level 2		2.312

Application Circuit Diagram



A03B25

Signal format	4 Fsc (MHz)
NTSC	3.579545 × 4
PAL	4.433618 × 4
SECAM	4.433618 × 4
PAL-M	3.575611 × 4
PAL-N	3.582056 × 4
NTSC4.43	4.433618 × 4
PAL60	4.433618 × 4

Signal format	SW1	SW2	SW3	SW4
NTSC	0	0	0	0
PAL	0	1	1	1
SECAM	1	(1)	(1)	(1)
PAL-M	0	0	1	0
PAL-N	0	1	1	0
NTSC4.43	0	0	0	1
PAL60	0	0	1	1

Note: Fix SW1 to SW4 to 0 when setting a mode by command.

- SANYO Semiconductor Co.,Ltd. assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein.
- SANYO Semiconductor Co.,Ltd. strives to supply high-quality high-reliability products, however, any and all semiconductor products fail or malfunction with some probability. It is possible that these probabilistic failures or malfunction could give rise to accidents or events that could endanger human lives, trouble that could give rise to smoke or fire, or accidents that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all SANYO Semiconductor Co.,Ltd. products described or contained herein are controlled under any of applicable local export control laws and regulations, such products may require the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written consent of SANYO Semiconductor Co.,Ltd.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the SANYO Semiconductor Co.,Ltd. product that you intend to use.
- Upon using the technical information or products described herein, neither warranty nor license shall be granted with regard to intellectual property rights or any other rights of SANYO Semiconductor Co.,Ltd. or any third party. SANYO Semiconductor Co.,Ltd. shall not be liable for any claim or suits with regard to a third party's intellectual property rights which has resulted from the use of the technical information and products mentioned above.

This catalog provides information as of September, 2011. Specifications and information herein are subject to change without notice.